

## Electronic Patent Application Fee Transmittal

Application Number:	10520444			
Filing Date:	06-Jan-2005			
<b>Title of Invention:</b> HYGROSCOPIC MOLDING				
First Named Inventor/Applicant Name:	Teruo Uchibori			
Filer:	Raymond D. Smith/MARY NGUYEN			
Attorney Docket Number:	SAEG103.003APC			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Certificate of correction	1811	1	100	100
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>100</b>